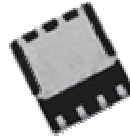


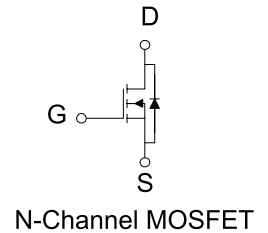
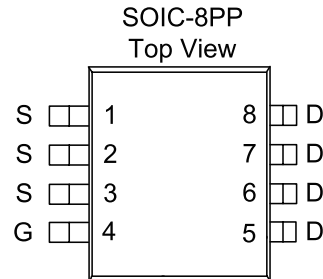
## N-Channel 80-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low  $r_{DS(on)}$  provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOIC-8PP saves board space
- Fast switching speed
- High performance trench technology



| PRODUCT SUMMARY |                            |           |
|-----------------|----------------------------|-----------|
| $V_{DS}$ (V)    | $r_{DS(on)}$ m( $\Omega$ ) | $I_D$ (A) |
| 80              | 26 @ $V_{GS} = 10V$        | 12        |
|                 | 36 @ $V_{GS} = 4.5V$       | 11        |



| ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) |                          |                |            |                  |
|-----------------------------------------------------------------------------|--------------------------|----------------|------------|------------------|
| Parameter                                                                   |                          | Symbol         | Maximum    | Units            |
| Drain-Source Voltage                                                        |                          | $V_{DS}$       | 80         | V                |
| Gate-Source Voltage                                                         |                          | $V_{GS}$       | 20         |                  |
| Continuous Drain Current <sup>a</sup>                                       | $T_A = 25^\circ\text{C}$ | $I_D$          | 12         | A                |
|                                                                             | $T_A = 70^\circ\text{C}$ |                | 9          |                  |
| Pulsed Drain Current <sup>b</sup>                                           |                          | $I_{DM}$       | 50         |                  |
| Continuous Source Current (Diode Conduction) <sup>a</sup>                   |                          | $I_S$          | 2.3        | A                |
| Power Dissipation <sup>a</sup>                                              | $T_A = 25^\circ\text{C}$ | $P_D$          | 5.0        | W                |
|                                                                             | $T_A = 70^\circ\text{C}$ |                | 3.2        |                  |
| Operating Junction and Storage Temperature Range                            |                          | $T_J, T_{stg}$ | -55 to 150 | $^\circ\text{C}$ |

| THERMAL RESISTANCE RATINGS               |                         |                 |         |                    |
|------------------------------------------|-------------------------|-----------------|---------|--------------------|
| Parameter                                |                         | Symbol          | Maximum | Units              |
| Maximum Junction-to-Ambient <sup>a</sup> | $t \leq 10 \text{ sec}$ | $R_{\theta JA}$ | 25      | $^\circ\text{C/W}$ |
|                                          | Steady State            |                 | 65      | $^\circ\text{C/W}$ |

Notes

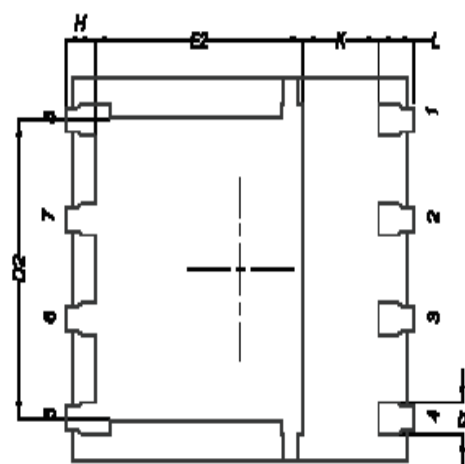
- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

| SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED) |                     |                                                                                                |        |     |     |      |
|---------------------------------------------------------------|---------------------|------------------------------------------------------------------------------------------------|--------|-----|-----|------|
| Parameter                                                     | Symbol              | Test Conditions                                                                                | Limits |     |     | Unit |
|                                                               |                     |                                                                                                | Min    | Typ | Max |      |
| Static                                                        |                     |                                                                                                |        |     |     |      |
| Gate-Threshold Voltage                                        | V <sub>GS(th)</sub> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 uA                                    | 1      |     |     | V    |
| Ghte-Body Leakage                                             | I <sub>GSS</sub>    | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 12 V                                                  |        |     | 100 | nA   |
| Zero Gate Voltage Drain Current                               | I <sub>DSS</sub>    | V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V                                                  |        |     | 1   | uA   |
|                                                               |                     | V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55°C                           |        |     | 5   |      |
| On-State Drain Current <sup>^</sup>                           | I <sub>D(on)</sub>  | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V                                                  | 40     |     |     | A    |
| Drain-Source On-Resistance <sup>^</sup>                       | r <sub>DS(on)</sub> | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A                                                   |        |     | 26  | mΩ   |
|                                                               |                     | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5 A                                                  |        |     | 36  |      |
| Forward Tranconductance <sup>^</sup>                          | g <sub>s</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 6 A                                                   |        | 40  |     | S    |
| Diode Forward Voltage                                         | V <sub>SD</sub>     | I <sub>S</sub> = 2.3 A, V <sub>GS</sub> = 0 V                                                  |        | 0.7 |     | V    |
| Dynamic <sup>b</sup>                                          |                     |                                                                                                |        |     |     |      |
| Total Gate Charge                                             | Q <sub>g</sub>      | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V,<br>I <sub>D</sub> = 6 A                       |        | 15  |     | nC   |
| Gate-Source Charge                                            | Q <sub>gs</sub>     |                                                                                                |        | 3   |     |      |
| Gate-Drain Charge                                             | Q <sub>gd</sub>     |                                                                                                |        | 5   |     |      |
| Turn-On Delay Time                                            | t <sub>d(on)</sub>  | V <sub>DD</sub> = 15 V, R <sub>L</sub> = 6Ω , I <sub>D</sub> = 1 A,<br>V <sub>GEN</sub> = 10 V |        | 15  |     | nS   |
| Rise Time                                                     | t <sub>r</sub>      |                                                                                                |        | 10  |     |      |
| Turn-Off Delay Time                                           | t <sub>d(off)</sub> |                                                                                                |        | 54  |     |      |
| Fall-Time                                                     | t <sub>f</sub>      |                                                                                                |        | 26  |     |      |

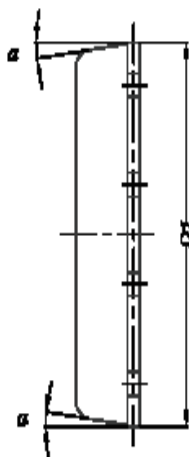
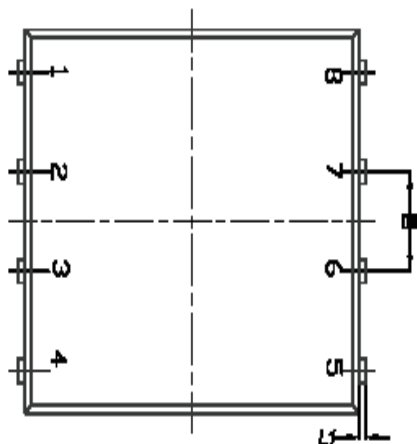
## Notes

- Pulse test:  $PW \leq 300 \mu\text{s}$  duty cycle  $\leq 2\%$ .
- Guaranteed by design, not subject to production testing.

# Package Information



BACKSIDE VIEW



| DIM. | MILLIMETERS |      |      |
|------|-------------|------|------|
|      | MIN.        | NOM. | MAX. |
| A    | 0.50        | 1.00 | 1.10 |
| b    | 0.33        | 0.41 | 0.51 |
| C    | 0.20        | 0.25 | 0.30 |
| D1   | 4.90        | 4.90 | 5.00 |
| D2   | 3.81        | 3.81 | 3.98 |
| E    | 5.00        | 6.00 | 8.10 |
| E1   | 5.70        | 6.75 | 5.00 |
| E2   | 3.98        | 3.88 | 3.78 |
| Ø    | 1.27 BSC    |      |      |
| H    | 0.41        | 0.51 | 0.81 |
| K    | 1.10        | -    | -    |
| L    | 0.51        | 0.61 | 0.71 |
| L1   | 0.08        | 0.13 | 0.20 |
| α    | 0°          | -    | 12°  |

